

A27C256 256K (32K x 8) CHMOS EPROM

Automotive

- **Extended Automotive Temperature** Range: -40°C to + 125°C
- CHMOS/NMOS Microcontroller and Microprocessor Compatible
 - Universal 28 Pin Memory Site, 2-line Control
- 120 ns Maximum Access Time
- **CMOS and TTL Compatible**
- **■** Low Power
 - - 30 mA Max. Active
 - -- 100 μA Max. Standby

- Fast Programming
 - Quick-Pulse Programming Algorithm
 - Programming Time as Fast as 4 Seconds
- Noise Immunity Features
 - ± 10% V_{CC} Tolerance
 - Maximum Latch-up Immunity through **EPI Processing**
- Available in 28-Pin Cerdip Package
 - 28-Pin Plastic Dip Package
 - Compact 32-Lead PLCC

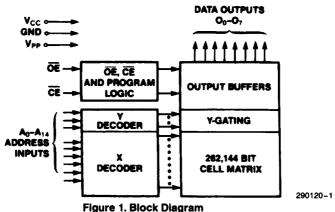
Intel's A27C256 is a 5V only, 262,144-bit Erasable Programmable Read Only Memory, organized as 32,768 words of 8 bits. Its standard pinouts provide for simple upgrades to 512 Kbits in the future in both DIP and SMT.

The A27C256 is ideal in embedded control applications based on advanced 16-bit CPUs. Fast 120 ns access times allow no-wait-state operation with the 12 MHz 80286. The A27C256 also excels in reprogrammable environments where the system designer must strike an optimal density/performance balance. For example, bootstrap and diagnostic routines run 1-wait-state on a 16 MHz 386TM microprocessor.

Intel offers two DIP profile options to meet your prototyping and production needs. The windowed ceramic dip (CERDIP) package provides erasability and reprogrammability for prototyping and early production. Once the design is in full production, the plastic dip (PDIP) one-time programmable part provides a lower cost alternative that is well adapted for auto insertion.

In addition to the JEDEC 28-pin DIP package, Intel also offers a 32-lead PLCC version of the A27C256. This one-time-programmable surface mount device is ideal where board space consumption is a major concern or where surface mount manufacturing technology is being implemented across an entire production line.

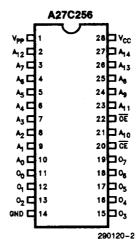
The A27C256 is equally at home in both TTL and CMOS environments. The Quick-Pulse programming algorithm improves speed as much as 100 times over older methods, further reducing cost for system manufacturers.



Pin Names

A ₀ -A ₁₅	ADDRESSES
O ₀ -O ₇	OUTPUTS
ŌĒ	OUTPUT ENABLE
CE	CHIP ENABLE
PGM	PROGRAM
NC	NO CONNECT
DU	DON'T USE

27512 27C512	27128A 27C128	2764A 27C64	2732A	2716
A ₁₅	Vpp	Vpp		
A ₁₂	A ₁₂	A ₁₂		
A ₇	A ₇	A ₇	A ₇	A ₇
A ₆	A ₆	A ₆	A ₆	Ae
A ₅	A ₅	A ₅	A ₅	A ₅
A ₄	A4	A ₄	A ₄	A ₄
A ₃	A ₃	A ₃	A ₃	A ₃
A ₂	A ₂	A ₂	A ₂	A ₂
A ₁	A ₁	A ₁	A ₁	A ₁
A ₀	A ₀	A ₀	Ao	Ao
00	00	00	00	00
01	01	01	0,	0,
02	02	02	02	02
GND	GND	GND	GND	GND



2716	2732A	27C64 27C64	27128A 27C128	27512 27C512
		Vcc	Vcc	Vcc
	'	PGM	PGM	A ₁₄
Vcc	Vcc	NC	A ₁₃	A ₁₃
A _B .	A ₈	A _B	A ₈	A ₈
A ₉	A ₉	Ag	A ₉	Ag
Vpp	A ₁₁	A ₁₁	A ₁₁	A ₁₁
ŌĒ	OE/V _{PP}	Œ	ÖĒ	OE/V _{PP}
A ₁₀	A ₁₀	A ₁₀	A ₁₀	A ₁₀
CE	CE	CE :	CE	CE
07	07	07	07	07
Oe	O ₆	O ₆	O ₆	O ₆
05	05	05	05	O ₅
04	04	04	04	04
03	O ₃	O ₃	О3	03

Figure 2. DIP Pin Configuration

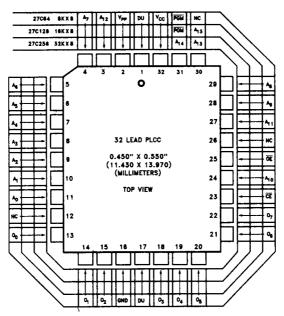


Figure 3. PLCC Lead Configuration

290120-3

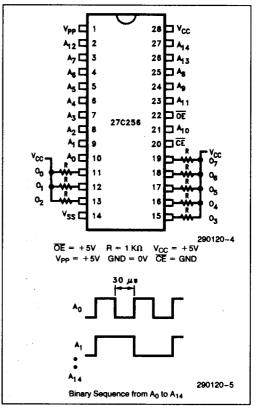
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AUTOMOTIVE TEMPERATURE EPROMS

The Intel AUTOMOTIVE EPROM family receives additional processing to enhance product characteristics. AUTOMOTIVE processing is available for several densities allowing the appropriate memory size to match system requirements. AUTOMOTIVE EPROMs are available with 168 ±8 hour, 125°C dynamic burn-in using Intel's standard bias configuration. This processing meets or exceeds most industry burn-in specifications. The AUTOMOTIVE product family is available in -40°C to 125°C operating temperature range versions. Like all Intel EPROMs, the AUTOMOTIVE EPROM family is inspected to 0.1% electrical AQL. This allows reduction or elimination of incoming testing.

Options

Speed	Packaging						
Speed	CerDiP	PLCC	PDIP				
-120V10	AD	AN	AP				
-200V10	AD	AN	AP				



Burn-in Bias and Timing Diagrams

ABSOLUTE MAXIMUM RATINGS*

Operating Temperature 40°C to 125°C
Temperature Under Bias 40°C to 125°C
Storage Temperature65°C to 150°C
Voltage on Any Pin (except A ₉ , V _{CC} and V _{PP}) with Respect to GND2V to 7V ⁽²⁾
Voltage on Ag with
Respect to GND2V to 13.5V(2)
V _{PP} Supply Voltage
with Respect to GND 2V to 14.0V(2)
V _{CC} Supply Voltage with
Respect to GND – 2V to 7.0V(2)
Maximum Junction Temperature (T _J)140°C

NOTICE: This is a production data sheet. The specifications are subject to change without notice.

*WARNING: Stressing the device beyond the "Absolute Maximum Ratings" may cause permanent damage. These are stress ratings only. Operation beyond the "Operating Conditions" is not recommended and extended exposure beyond the "Operating Conditions" may affect device reliability.

READ OPERATION DC CHARACTERISTICS(1) V_{CC} = 5.0V ± 10%

Symbol	Parameter	Notes	Min	Тур	Max	Unit	Test Conditions
ILI	Input Load Current	7		0.01	1.0	μΑ	$V_{IN} = 0V \text{ to } V_{CC}$
lLO	Output Leakage Current				±10	μΑ	$V_{OUT} = 0V \text{ to } V_{CC}$
I _{SB}	V _{CC} Standby Current				1.0	mA	CE = VIH
					100	μΑ	$\overline{CE} = V_{CC} \pm 0.2V$
lcc	V _{CC} Operating Current	3			30	mA	CE = V _{IL} f = 5 MHz
lpp	V _{PP} Operating Current	3			200	μΑ	$V_{PP} = V_{CC}$
los	Output Short Circuit Current	4, 6			100	mA	
V _{IL}	Input Low Voltage		-0.5		0.8	٧	
V _{IH}	Input High Voltage		2.0		V _{CC} + 0.5	٧	
VOL	Output Low Voltage				0.45	٧	I _{OL} = 2.1 mA
VoH	Output High Voltage		2.4			٧	$I_{OH} = -400 \mu A$
V _{PP}	V _{PP} Operating Voltage	5	V _{CC} - 0.7		Vcc	٧	

NOTES:

- 1. Minimum DC voltage is -0.5V on input/output pins. During transitions, this level may undershoot to -2.0V for periods <20 ns. Maximum DC voltage on input/output pins is $V_{CC} + 0.5$ V which, during transitions, may overshoot to $V_{CC} + 2.0$ V for periods <20 ns.
- 2. Maximum active power usage is the sum Ipp + ICC. Maximum current value is with outputs Oo to O7 unloaded.
- 3. Output shorted for no more than one second. No more than one output shorted at a time.
- 4. V_{PP} may be connected directly to V_{CC}, or may be one diode voltage drop below V_{CC}. V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP}.
- 5. Sampled, not 100% tested.
- 6. Typical limits are at $V_{CC} = 5V$, $T_A = 25$ °C.



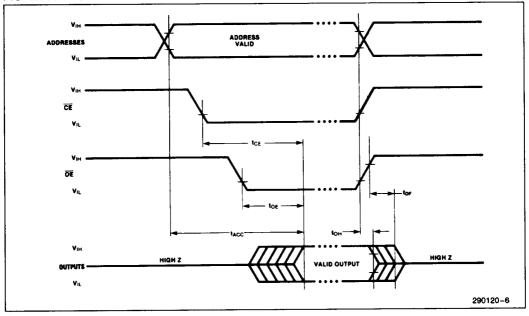
READ OPERATION AC CHARACTERISTICS(1) $V_{CC} = 5.0V \pm 10\%$

	Versions		A27C25	A27C256-120V10		A27C256-200V10		
Symbol	Parameter	Notes	Min	Max	Min	Max	Unit	
t _{ACC}	Address to Output Delay			120		200	ns	
t _{CE}	CE to Output Delay	2		120		200	ns	
^t OE	OE to Output Delay	2		55		75	ns	
tDF	OE High to Output High Z	3		30		55	ns	
tон	Output Hold from Addresses, CE or OE Change-Whichever is First	3	0		0		ns	

NOTES:

See AC Input/Output Reference Waveform for timing measurements.
 DE may be delayed up to t_{CE}-t_{OE} after the falling edge of CE without impact on t_{CE}.
 Sampled, not 100% tested.

AC WAVEFORMS



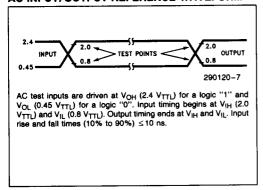
CAPACITANCE(1) T_A = 25°C, f = 1.0 MHz

Symbol	Parameter	Max	Units	Conditions
CiN	Address/Control Capacitance	6	pF	$V_{IN} = 0V$
C _{OUT}	Output Capacitance	12	pF	V _{OUT} = 0V

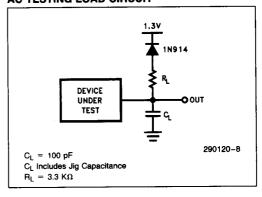
NOTE:

1. Sampled, not 100% tested.

AC INPUT/OUTPUT REFERENCE WAVEFORM



AC TESTING LOAD CIRCUIT



5



DEVICE OPERATION

The Mode Selection table lists A27C256 operating modes. Read Mode requires a single 5V power supply. All inputs, except V_{CC} and V_{PP}, and A₉ during Intelligent Identifier Mode, are TTL or CMOS.

Table 1. Mode Selection

Mode	Notes	CE	ŌĒ	Ag	A ₀	V _{PP}	Vcc	Outputs
Read	1	V _{IL}	V _{IL}	×	×	Vcc	Vcc	D _{OUT}
Output Disable		V _I L	V _{IH}	Х	X	Vcc	Vcc	High Z
Standby		V _{IH}	X	х	×	Vcc	Vcc	High Z
Program	2	V _{IL}	V _{IH}	×	×	V _{PP}	V _{CP}	DIN
Program Verify		VIH	V _{IL}	Х	. X	V _{PP}	V _{CP}	D _{OUT}
Program Inhibit		V _{IH}	V _{IH}	х	Х	V _{PP}	V _{CP}	HIGH Z
Intelligent Identifier -Manufacturer	2, 3	V _{IL}	V _{IL}	V _{ID}	V _{IL}	V _{CC}	Vcc	89 H
Intelligent Identifier -Device	2, 3, 4	V _{IL}	V _{IL}	V _{ID}	V _{IH}	Vcc	Vcc	8D H

NOTES:

- 1. X can be VIL or VIH.
- 2. See DC Programming Characteristics for VCP, VPP and VID voltages.
- 3. $A_1 A_8$, $A_{10-14} = V_{II}$.
- 4. Programming equipment may also refer to this device as the A27C256A. Older devices may have device ID = 8CH.

Read Mode

The A27C256 has two control functions, both must be enabed to obtain data at the outputs. \overline{CE} is the power control and device select. \overline{OE} controls the output buffers to gate data to the outputs. With addresses stable, the address access time (t_{ACC}) equals the delay from \overline{CE} to output (t_{CE}). Outputs display valid data t_{OE} after \overline{OE} 's falling edge, assuming t_{ACC} and t_{CE} times are met.

 V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP} .

Two Line Output Control

EPROMs are often used in larger memory arrays. Intel provides two control inputs to accommodate multiple memory connections. Two-line control provides for:

- a) lowest possible memory power dissipation
- b) complete assurance that data bus contention will not occur

To efficiently use these two control inputs, an address decoder should enable \overline{CE} , while \overline{OE} should be connected to all memory devices and the system's \overline{READ} control line. This assures that only selected memory devices have active outputs while deselected memory devices are in Standby Mode.

Standby Mode

Standby Mode substantially reduces V_{CC} current. When $\overline{CE}=V_{IH}$, the outputs are in a high impedance state, independent of \overline{OE} .

Program Mode

Initially, and after each erasure, all EPROM bits are in the "1" state. Data is introduced by selectively programming "0's" into the desired bit locations. Although only "0's" are programmed, the data word can contain both "1's" and "0's". Ultraviolet light erasure is the only way to change "0's" to "1's".

Program Mode is entered when V_{PP} is raised to 12.75V. Data is introduced by applying an 8-bit word to the output pins. Pulsing $\overline{\text{CE}}$ low while $\overline{\text{OE}} = V_{IH}$ programs that data into the device.

Program Verify

A verify should be performed following a program operation to determine that bits have been correctly programmed. With V_{CC} at 6.25V a substantial program margin is ensured. The verify is performed with \overline{CE} at V_{IH} . Valid data is available t_{OE} after \overline{OE} falls low.

Program Inhibit

Program Inhibit Mode allows parallel programming of multiple EPROMs with different data. CE-high inhibits programming of non-targeted devices. Except for CE and OE, parallel EPROMs may have common inputs.

Intelligent Identifier Mode

The intelligent Identifier Mode will determine an EPROM's manufacturer and device type, allowing programming equipment to automatically match a device with its proper programming algorithm.

This mode is activated when a programmer forces 12V + 0.5V on A_9 . With \overline{CE} , \overline{OE} , A_1-A_9 , and $A_{10}-A_{14}$ at V_{IL} , $A_0 = V_{IL}$ will present the manufacturer code and $A_0 = V_{IH}$ the device code. This mode functions in the $25^{\circ}C \pm 5^{\circ}C$ ambient temperature range required during programming.

UPGRADE PATH

Future upgrade to the 512 Kbit density is easily accomplished due to the standardized pin configuration of the A27C256. A jumper between A₁₅ and V_{CC}

allows upgrade using the V_{PP} pin. Systems designed for 256 Kbit program memories today can be upgraded to 512 Kbit in the future with no circuit board changes.

SYSTEM CONSIDERATIONS

EPROM power switching characteristics require careful device decoupling. System designers are interested in 3 supply current issues: standby current levels (ISB), active current levels (ICC), and transient current peaks produced by falling and rising edges of CE. Transient current magnitudes depend on the device output's capacitive and inductive loading. Two-Line Control and proper decoupling capacitor selection will suppress transient voltage peaks. Each device should have a 0.1 µF ceramic capacitor connected between its V_{CC} and GND. This high frequency, low inherent-inductance capacitor should be placed as close as possible to the device. Additionally, for every 8 devices, a 4.7 µF electrolytic capacitor should be placed at the array's power supply connection between VCC and GND. The bulk capacitor will overcome voltage slumps caused by PC board trace inductances.

ERASURE CHARACTERISTICS

Erasure begins when EPROMs are exposed to light with wavelengths shorter than approximately 4000 Angstroms (Å). It should be noted that sunlight and certain flourescent lamps have wavelengths in the 3000Å-4000Å range. Data shows that constant exposure to room level fluorescent lighting can erase an EPROM in approximately 3 years, while it takes approximately 1 week when exposed to direct sunlight. If the device is exposed to these lighting conditions for extended periods, opaque labels should be placed over the window to prevent unintentional erasure.

The recommended erasure procedure is exposure to ultraviolet light of wavelength 2537Å. The integrated dose (UV intensity x exposure time) for erasure should be a minimum of 15 Wsec/cm². Erasure time is approximately 15 to 20 minutes using an ultraviolet lamp with a 12000 $\mu\text{W/cm}^2$ power rating. The EPROM should be placed within 1 inch of the lamp tubes. An EPROM can be permanently damaged if the integrated dose exceeds 7258 Wsec/cm² (1 week @ 12000 $\mu\text{W/cm}^2$).

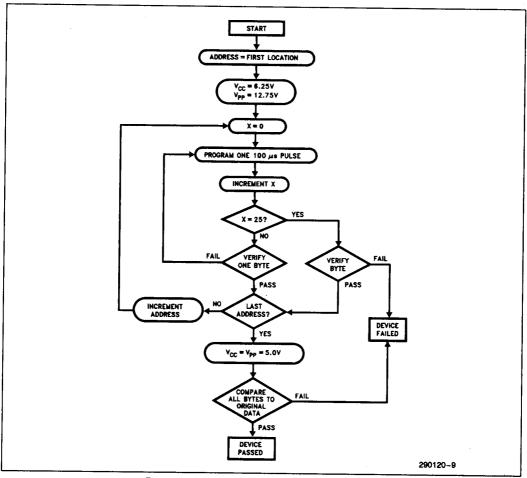


Figure 4. Quick-Puise Programming Algorithm

Quick-Pulse Programming Algorithm

The Quick-Pulse Programming algorithm programs Intel's A27C256. Developed to substantially reduce programming throughput, this algorithm can program the A27C256 as fast as 4 seconds. Actual programming time depends on programmer overhead.

The Quick-Pulse programming algorithm employs a 100 µs pulse followed by a byte verification to determine when the addressed byte has been successfully programmed. The algorithm terminates if 25 attempts fail to program a byte.

The entire program pulse/byte verify sequence is performed with $V_{PP}=12.75V$ and $V_{CC}=6.25V$. When programming is complete, all bytes are compared to the original data with $V_{CC}=V_{PP}=5.0V$.

In addition to the Quick-Pulse Programming Algorithm, the A27C256 has also been characterized for the Quick-Board Programming Algorithm. The Quick-Board Programming Algorithm was developed for specific automotive applications using Intel's 1.0 micron EPROM products. Contact the factory or an automotive sales representative for any information regarding the Quick-Board Programming Algorithm.

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DC PROGRAMMING CHARACTERISTICS TA = 25°C ±5°C

Symbol	Parameter	Notes	Min	Тур	Max	Unit	Test Condition
ILI	Input Load Current				1.0	μΑ	$V_{IN} = V_{IL} \text{ or } V_{IH}$
ICP	V _{CC} Program Current	1			30	mA	CE = VIL
Ipp	V _{PP} Program Current	1			50	mA	CE = VIL
VIL	Input Low Voltage		-0.1		0.8	٧	
V _{IH}	Input High Voltage		2.4		6.5	٧	
V _{OL}	Output Low Voltage (Verify)				0.45	٧	I _{OL} = 2.1 mA
V _{OH}	Output High Voltage (Verify)		3.5			٧	$I_{OH} = -2.5 \text{ mA}$
V _{ID}	A ₉ Intelligent Identifier Voltage		11.5	12.0	12.5	٧	
V _{PP}	V _{PP} Program Voltage	2, 3	12.5	12.75	13.0	٧	
V _{CP}	V _{CC} Supply Voltage (Program)	2	6.0	6.25	6.5	٧	

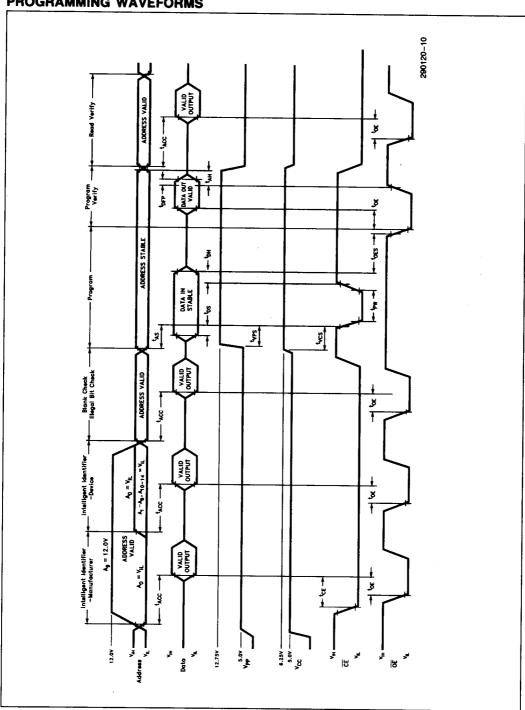
AC PROGRAMMING CHARACTERISTICS(4) $T_A = 25^{\circ}C \pm 5^{\circ}C$

Symbol	Parameter	Notes	Min	Тур	Max	Unit
tycs	V _{CP} Setup Time	2	2			μs
tvps	V _{PP} Setup Time	2	2			μs
tas	Address Setup Time		2			μs
t _{DS}	Data Setup Time		2			μs
tpw	CE Program Pulse Width		95	100	105	μs
t _{DH}	Data Hold Time		2			μs
toes	OE Setup Time		2			μs
t _{OE}	Data Valid from OE	5			150	ns
t _{DFP}	OE High to Output High Z	5, 6	0		130	ns
t _{AH}	Address Hold Time		0			μs

NOTES:

- 1. Maximum current value is with outputs $\mathbf{0}_0$ to $\mathbf{0}_7$ unloaded.
- 2. V_{CP} must be applied simultaneously or before V_{PP} and removed simultaneously or after $V_{PP}.\;$
- 3. When programming, a 0.1 μ F capacitor is required across Vpp and GND to suppress spurious voltage transients which can damage the device.
- See AC Input/Output Reference Waveform for timing measurments.
- 5. $t_{\mbox{OE}}$ and $t_{\mbox{DFP}}$ are device characteristics but must be accommodated by the programmer.
- 6. Sampled, not 100% tested.

PROGRAMMING WAVEFORMS



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